DECLARATION FOR U.S. PATENT APPLICATION

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

inventor (if plu the invention e		re listed below) of	the subject matter which	is claimed and for which a p	atent is sought on
EPITA	KIAL WAF	ER PRODUCTIO	N APPARATUS AND	SUSCEPTOR STRUCTUR	E
:					
the specification	n of which	is attached hereto t	unless the following is ch	ecked	
		United States Appli (if applicable).	cation Number or	PCT International Application	on Number
		eviewed and under ny amendment refe		above-identified specification	, including the
I acknowledge Federal Regula			n which is material to pa	tentability as defined in Title	37, Code of
application(s) f	or patent or tor's certific	inventor's certific	ate listed below and have	Code, § 119 (a) – (d) of any for also identified below any for optication for which priority	reign application for
applications. See		-220027	Japan	29/7/2002	X Yes No
note A below)		(Number)	(Country)	(Day/Month/Year Filed)	
•					☐ Yes ☐ No
	••••••	(Number)	(Country)	(Day/Month/Year Filed)	
					m, m,
		(Number)	(Country)	(Day/Month/Year Filed)	Yes No
		(Number)	(Country)	(Day/Month/Year Filed)	Yes No
(See note B bel		`	thed list for additional pr	•	
and, insofar as application in duty to disclos	the subjec the manner e informatio came availa	t matter of each of provided by the formatter is matter the little between the little is matter the little between the little b	f the claims of this applies the paragraph of Title 3 along to patentability as de	O of any United States application is not disclosed in the States Code, § 11 fined in Title 37, Code of Fupplication and the national	ne prior United States 2, I acknowledge the ederal Regulations, §
				Stat	us
(List prior U.S. Applications)	(Applicati	ion Serial No.)	(Filing Date)	Patented Pend	ding 🗌 Abandoned
	/ - F. K. ranier		(, 6 = 2. (4)	·	
	(Applicati	ion Serial No.)	(Filing Date)	Patented Pend	ding 🗌 Abandoned
				Patented Pend	ding 🗌 Abandoned
	(Applicati	ion Serial No.)	(Filing Date)		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



Please direct all communications to the following address:



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PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or fi	rst inventor (given name, family name)	Hidemasa KAI				
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	Inventor's signature		Date				
·	Residence		Citizenship				
	Post Office Address						
			-				
	Full name of third inventor (given name, family name)						
	Inventor's signature		Date				
	Residence		Citizenship				
	Post Office Address						
	Full name of fourth inventor (given name, family name)						
	Inventor's signature		Date				
	Residence	•	Citizenship				
	Post Office Address						
	Full name of fifth inventor (given name, family name)						
	Inventor's signature	(82.011.12.100)	Date				
	Residence		Citizenship				
	Post Office Address						